**NIKO-SEM**

# N-Channel Enhancement Mode Field Effect Transistor

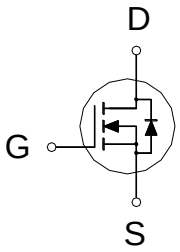
# PKC26BB

**PDFN 5x6P**

**Halogen-Free & Lead-Free**

## PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | $I_D$[4] |
|---|---|---|
| 30V | 1.6mΩ | 151A |

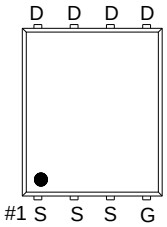



### Features

- Pb−Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

### Applications

- Protection Circuits Applications.
- Computer for DC to DC Converters Applications.




G. GATE
D. DRAIN
S. SOURCE

100% UIS Tested
100% Rg Tested

## ABSOLUTE MAXIMUM RATINGS ($T_A$ = 25 °C Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|---|---|---|---|---|
| Drain-Source Voltage | | $V_{DS}$ | 30 | V |
| Gate-Source Voltage | | $V_{GS}$ | ±20 | V |
| Continuous Drain Current[4] | $T_C$ = 25 °C | $I_D$ | 151 | A |
| | $T_C$ = 100 °C | | 95 | |
| Pulsed Drain Current[1] | | $I_{DM}$ | 200 | |
| Continuous Drain Current | $T_A$ = 25 °C | $I_D$ | 36 | |
| | $T_A$ = 70 °C | | 28 | |
| Avalanche Current | | $I_{AS}$ | 57 | |
| Avalanche Energy | L = 0.1mH | $E_{AS}$ | 162 | mJ |
| Power Dissipation | $T_C$ = 25 °C | $P_D$ | 73 | W |
| | $T_C$ = 100 °C | | 29 | |
| Power Dissipation[3] | $T_A$ = 25 °C | $P_D$ | 4.1 | W |
| | $T_A$ = 70 °C | | 2.6 | |
| Operating Junction & Storage Temperature Range | | $T_j$, $T_{stg}$ | -55 to 150 | °C |

## THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|---|---|---|---|---|---|
| Junction-to-Ambient[2] | t ≦10s | $R_{\theta JA}$ | | 30 | °C / W |
| Junction-to-Ambient[2] | Steady-State | $R_{\theta JA}$ | | 50 | |
| Junction-to-Case | Steady-State | $R_{\theta JC}$ | | 1.7 | |

[1]Pulse width limited by maximum junction temperature.
[2]The value of $R_{\theta JA}$ is measured with the device mounted on 1in$^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A$ =25°C.
[3]The Power dissipation is based on $R_{\theta JA}$ t ≦10s value.
[4]The maximum current rating is package limited.

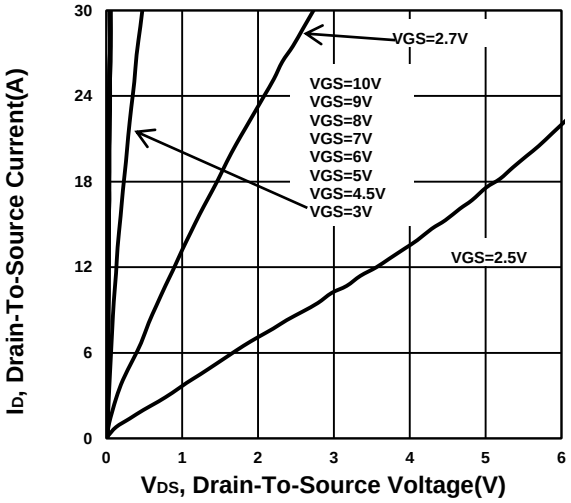
## ELECTRICAL CHARACTERISTICS ($T_J$ = 25 °C, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS MIN | LIMITS TYP | LIMITS MAX | UNIT |
|---|---|---|---|---|---|---|
| **STATIC** | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}$ = 0V, $I_D$ = 250μA | 30 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250μA | 1.3 | 1.6 | 2.35 | |
| Gate-Body Leakage | $I_{GSS}$ | $V_{DS}$ = 0V, $V_{GS}$ = ±20V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 24V, $V_{GS}$ = 0V | | | 1 | μA |
| | | $V_{DS}$ = 20V, $V_{GS}$ = 0V, $T_J$ = 55 °C | | | 3 | |
| Drain-Source On-State Resistance[1] | $R_{DS(ON)}$ | $V_{GS}$ = 4.5V, $I_D$ = 20A | | 1.6 | 2.3 | mΩ |
| | | $V_{GS}$ = 10V, $I_D$ = 20A | | 1.1 | 1.6 | |
| Forward Transconductance[1] | $g_{fs}$ | $V_{DS}$ = 5V, $I_D$ = 20A | | 123 | | S |
| **DYNAMIC** | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{GS}$ = 0V, $V_{DS}$ = 15V, f = 1MHz | | 3499 | | pF |
| Output Capacitance | $C_{oss}$ | | | 625 | | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | 408 | | |
| Gate Resistance | $R_g$ | $V_{GS}$ = 0V, $V_{DS}$ = 0V, f = 1MHz | | 1.1 | | Ω |
| Total Gate Charge[2] | $Q_g$ $V_{GS}$ = 10V | $V_{DS}$ = 15V , $V_{GS}$ = 10V, $I_D$ = 20A | | 70 | | nC |
| | $Q_g$ $V_{GS}$ = 4.5V | | | 36 | | |
| Gate-Source Charge[2] | $Q_{gs}$ | | | 9.2 | | |
| Gate-Drain Charge[2] | $Q_{gd}$ | | | 17 | | |
| Turn-On Delay Time[2] | $t_{d(on)}$ | $V_{DS}$ = 15V , $I_D$ ≅ 20A, $V_{GS}$ = 10V, $R_{GEN}$ =6Ω | | 20 | | nS |
| Rise Time[2] | $t_r$ | | | 120 | | |
| Turn-Off Delay Time[2] | $t_{d(off)}$ | | | 97 | | |
| Fall Time[2] | $t_f$ | | | 150 | | |

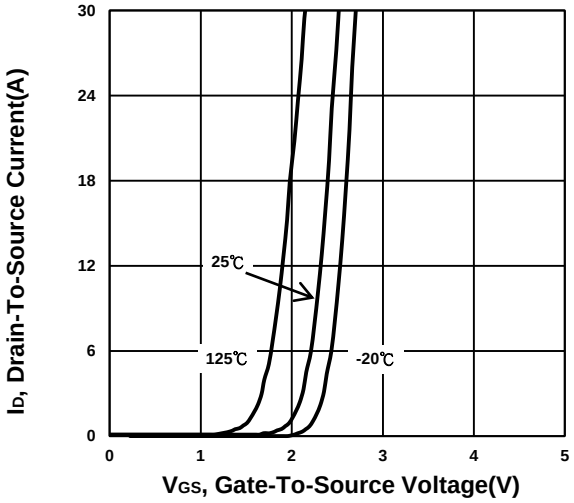
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J$ = 25 °C) | | | | | | |
|---|---|---|---|---|---|---|
| Continuous Current[3] | $I_S$ | | | | 73 | A |
| Forward Voltage[1] | $V_{SD}$ | $I_F$ = 20A, $V_{GS}$ = 0V | | | 1 | V |
| Reverse Recovery Time | $t_{rr}$ | $I_F$ = 20A, $dI_F/dt$ = 100A / μS | | 28 | | nS |
| Reverse Recovery Charge | $Q_{rr}$ | | | 13 | | nC |

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.
[3]The maximum current rating is package limited.

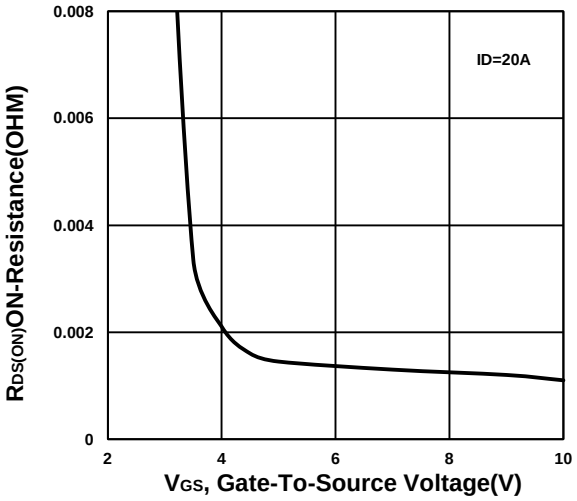
## Output Characteristics



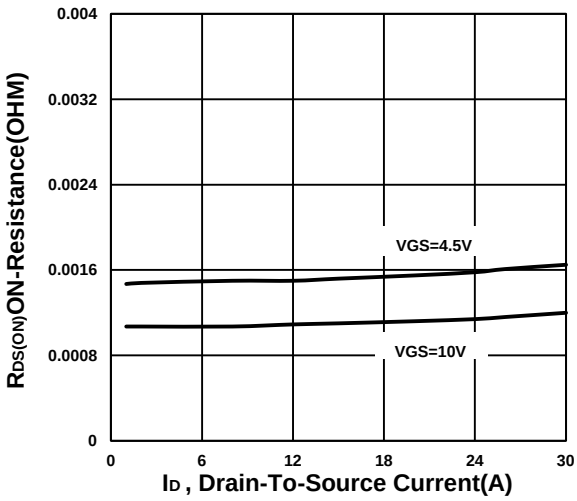

## Transfer Characteristics



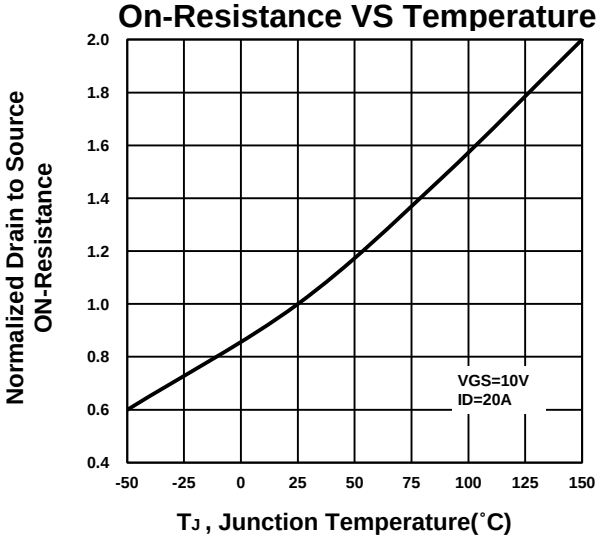

## On-Resistance VS Gate-To-Source



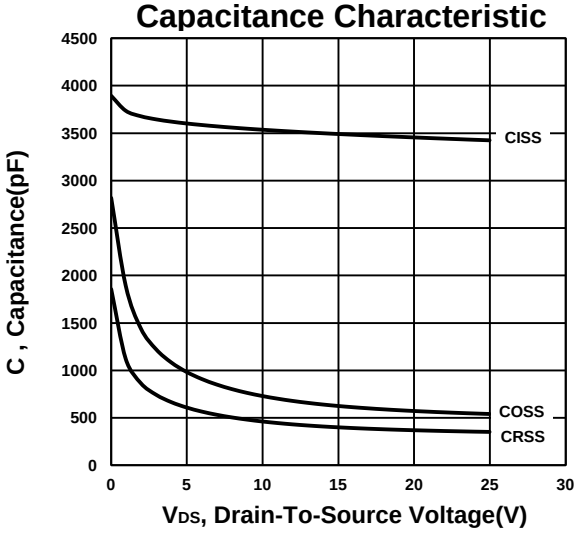

## On-Resistance VS Drain Current



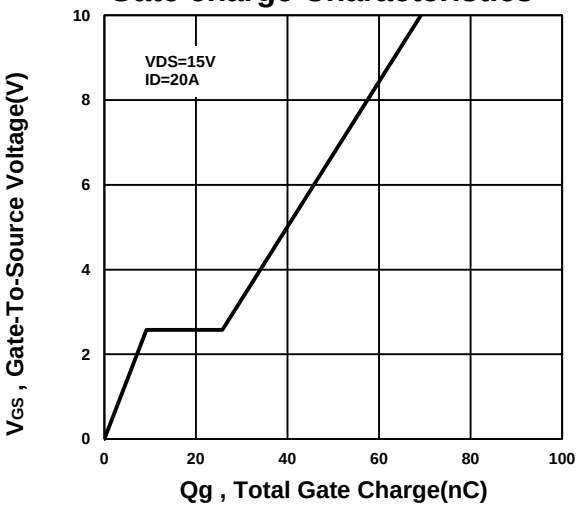

## On-Resistance VS Temperature



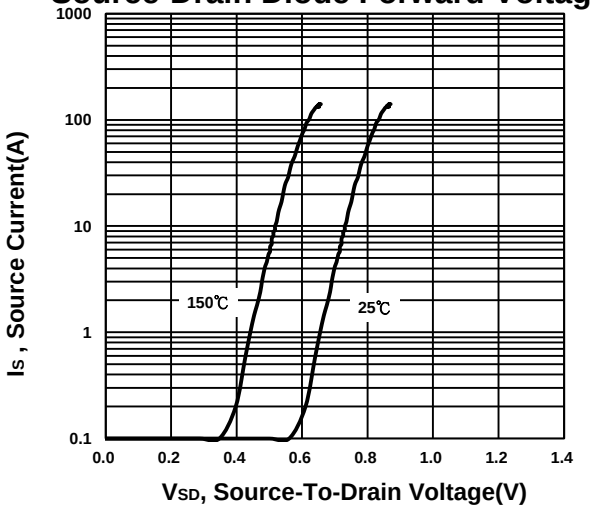

## Capacitance Characteristic



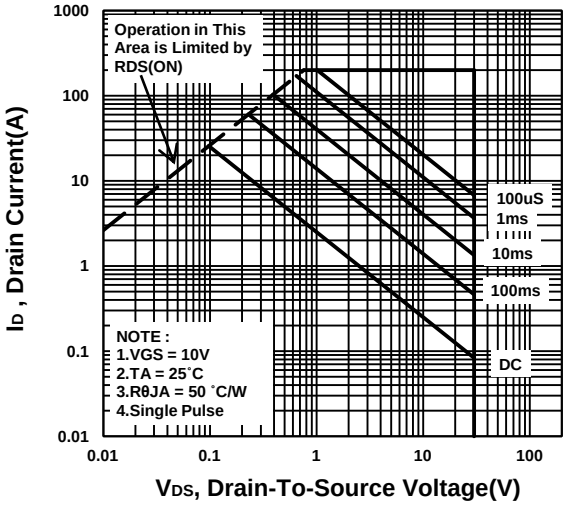
## Gate charge Characteristics



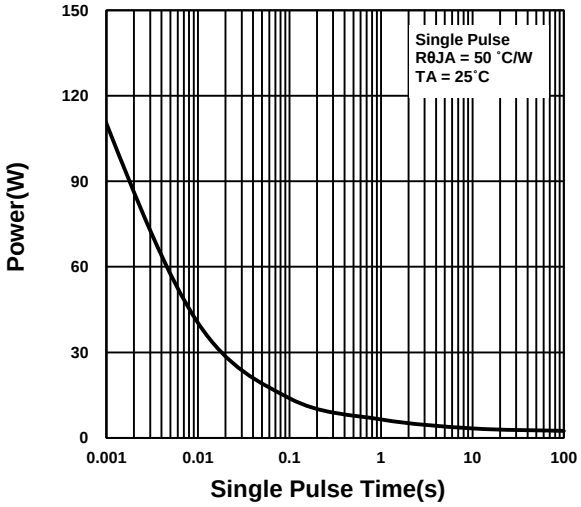

## Source-Drain Diode Forward Voltage



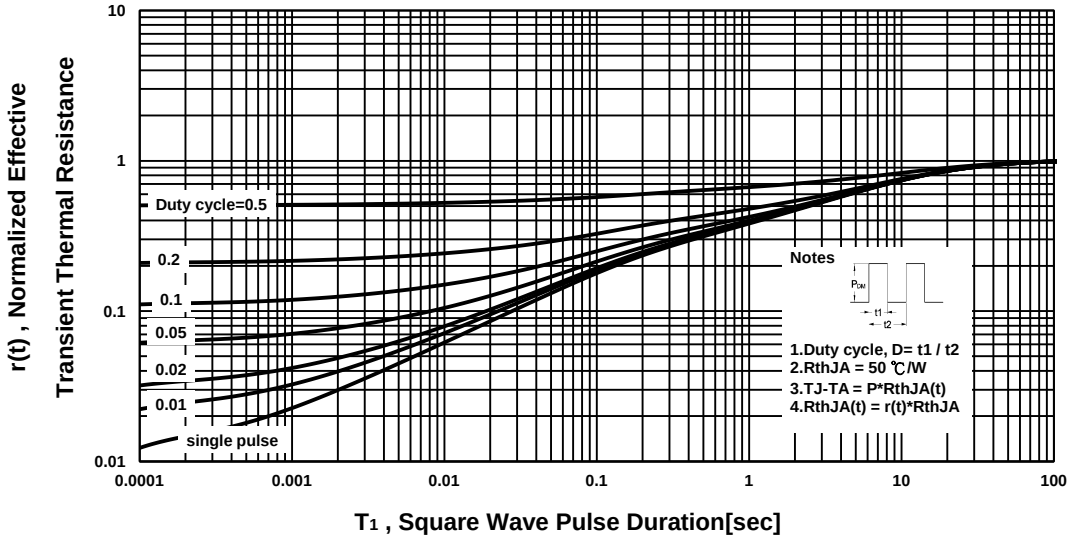

## Safe Operating Area




## Single Pulse Maximum Power Dissipation




## Transient Thermal Response Curve



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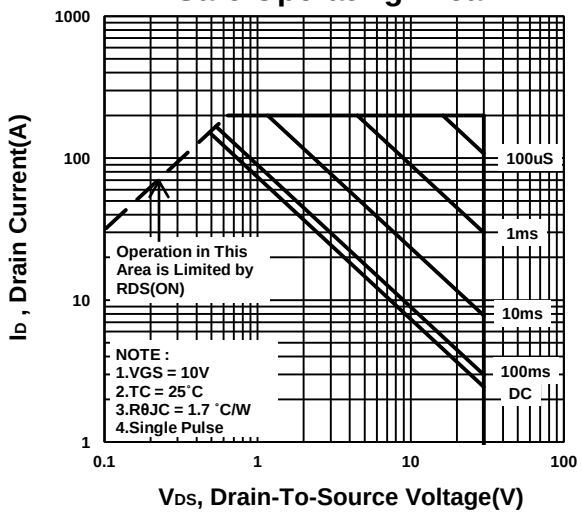


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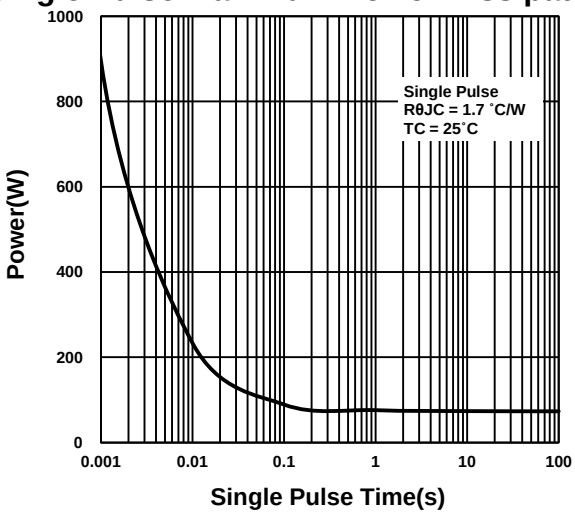


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